









Release Date: 30 December 2022 Version: A1.1

PRODUCT DATASHEET



- ► PLCC2 SMD
- ▶ 2835 0.7t
- ► Cool White (6500K)

NOW50S05 (3/5 STEP)





2835 PLCC2 Series Compliant





FEATURES:

- Package: PLCC2 Top View White Package
- Forward Current: 150mA Forward Voltage (typ.): 2.9V
- Luminous Flux (typ.): 75lm@150mA
- Colour: Cool White
- Colour Temperature (CCT): 6500K
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - Finish: Ag plated
- Operating Temperature: -40~+105°C Storage Temperature: -40~+100°C
- **Electrostatics Discharge: 1000V**
- **Grouping parameters:**
 - Forward Voltage
 - Luminous Flux
 - **CIE Chromaticity**
- Soldering methods: Reflow Soldering
- MSL Level: according to J-STD020 Level 3
- Packing: 8mm tape with max.16000/reel, ø330mm/13"

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD
- **Architectural Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	l _F	180	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	IPF	270	mA
Power Dissipation	P _D	576	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	120	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{THJS}	22	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	230 or 260 for 10S	°C

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

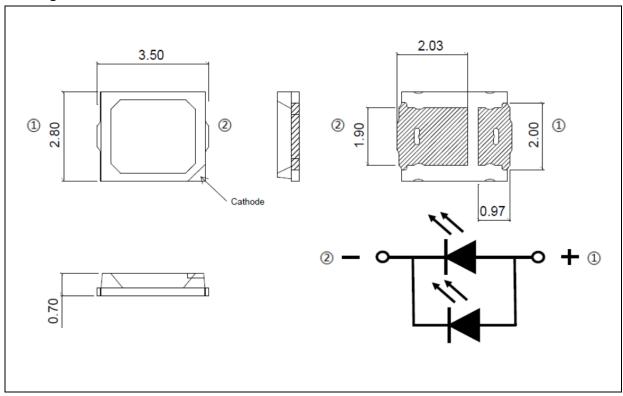
Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	V _F	2.8		3.2	V	I _F =150mA
Luminous Flux	Ф۷	70	75	85	lm	I _F =150mA
Chromaticity Coordinates	Х		0.3187			I _F =150mA
	Υ		0.3363			
Colour Temperature	ССТ	1	6500		К	I _F =150mA
Colour Rendering Index	CRI	80	82			I _F =150mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =150mA

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V



OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 150mA):

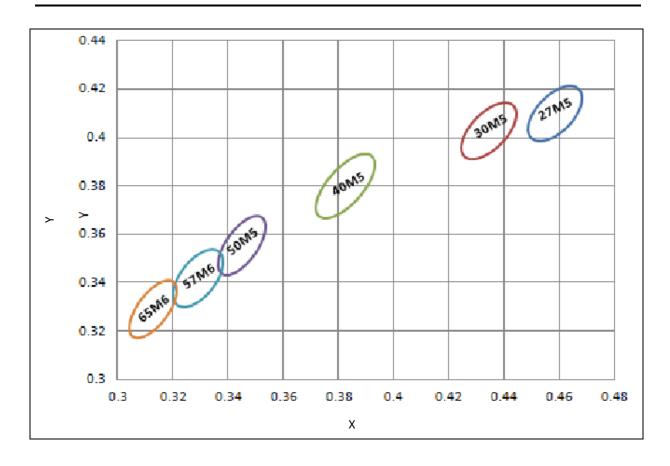
Code	Min.	Max.	Unit
B1	2.8	2.9	
C1	2.9	3.0	V
D1	3.0	3.1	V
E1	3.1	3.2	

Luminous Flux Classifications (I_F = 150mA):

Code	Min.	Max.	Unit	
1W	70	75		
1X	75	80	lm	
5A	80	85		



CIE CHROMATICITY DIAGRAM:

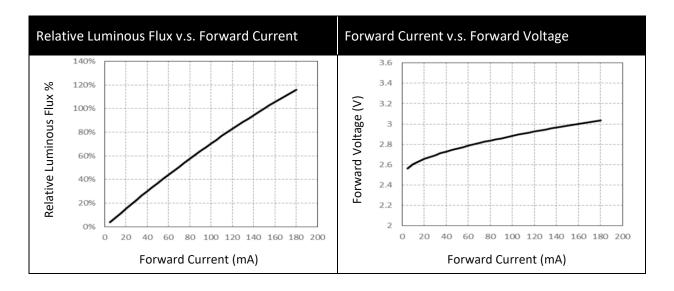


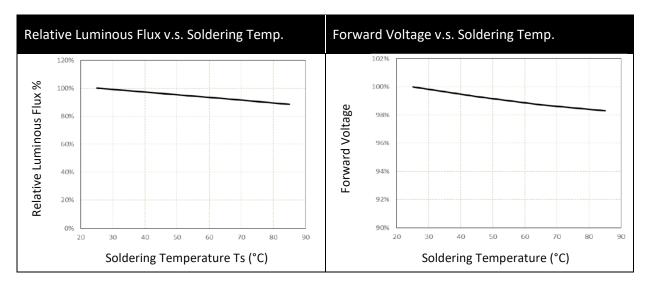
Chromaticity Coordinates Classifications (IF = 150mA):

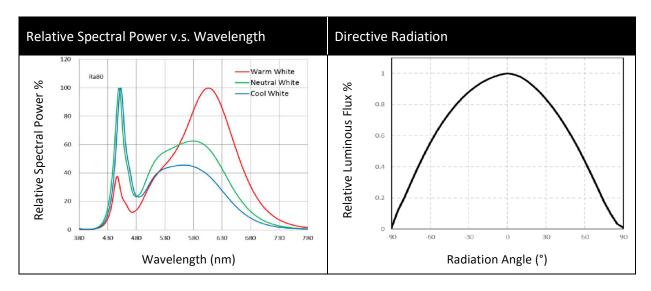
	Code	Centre		Radius		Angle
a /		Х	Υ	а	b	Φ
D D	65R5	0.3187	0.3363	0.011150	0.004750	58.34



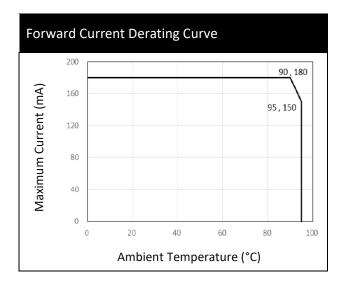
ELECTRO-OPTICAL CHARACTERISTICS:







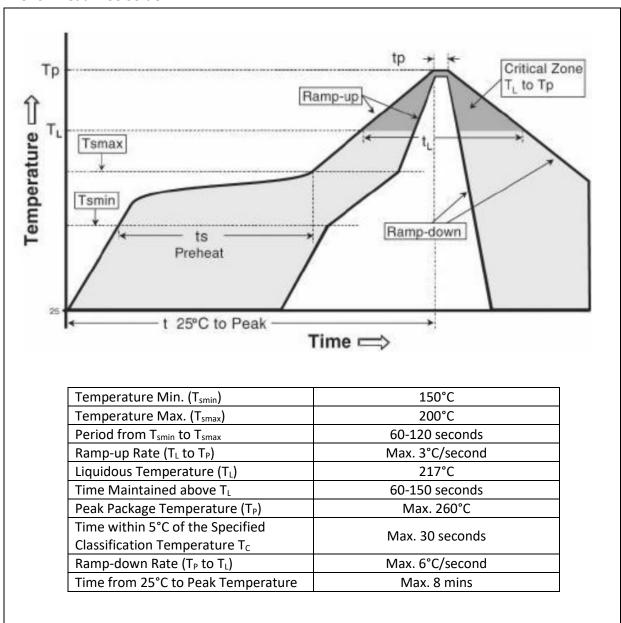






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



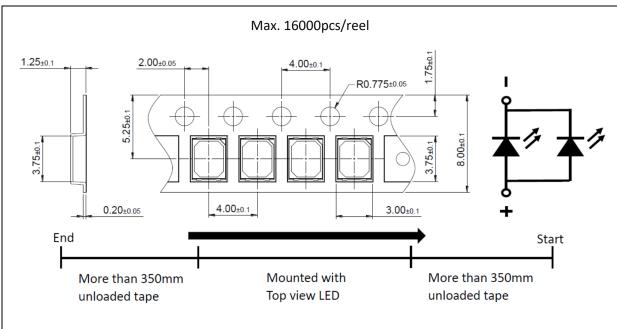
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

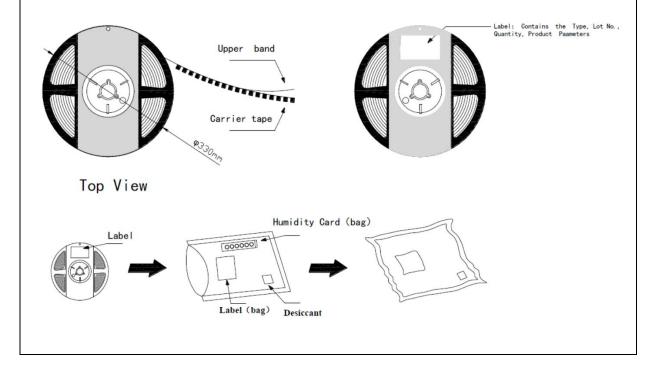


PACKING SPECIFICATION:

Reel Dimension:



1. Cumulative Tolerance: Cumulative Tolerance/10 pitches to be ±0.2mm





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

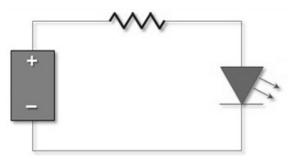
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, worktables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	21/01/2021	Datasheet set-up.
A1.1	30/12/2022	Update working temperature maximum.